

#### **Features**

- Halogen Free. "Green" Device (Note 1)
- · AEC-Q101 Qualified
- High Conductance
- · Fast Switching Speed
- Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

- Operating Junction Temperature Range: -65°C to +150°C
- Storage Temperature Range: -65°C to +150°C
- Thermal Resistance : 357°C/W Junction to Ambient(Note 2)

MCC Part Number	Repetitive Peak Reverse Voltage V <sub>RRM</sub>	RMS Reverse Voltage V <sub>R(RMS)</sub>	DC Blocking Voltage V <sub>R</sub>
BAS19HE3	120V	85V	120V
BAS20HE3	200V	141V	200V
BAS21HE3	250V	177V	250V

### Electrical Characteristics @ 25°C Unless Otherwise Specifie

Average Rectified Forward Current	I <sub>F(AV)</sub>	225mA	(Note 2)
Non-Repetitive Peak Forward Surge Current	I <sub>FSM</sub>	9.0A 0.5A	@ t=1us @ t=1s
Repetitive Peak Forward Curren	I <sub>FRM</sub>	625mA	
Power Dissipation	P <sub>TOT</sub>	350mW	T <sub>A</sub> =25°C

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. Mounted on FR-4 board with recommended pad layout.

#### **Internal Structure and Marking Code**









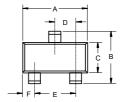
BAS19HE3

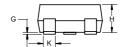
BAS20HE3

BAS21HE3

# 350mW Small Signal Diodes

# SOT-23

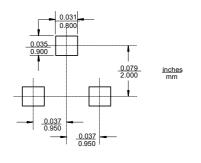






DIMENSIONS						
DIM INC		HES	MM		NOTE	
DIIVI	MIN	MAX	MIN MAX		NOTE	
Α	0.110	0.120	2.80	3.04		
В	0.083	0.104	2.10	2.64		
С	0.047	0.055	1.20	1.40		
D	0.034	0.041	0.85	1.05		
Е	0.067	0.083	1.70	2.10		
F	0.018	0.024	0.45	0.60		
G	0.0004	0.006	0.01	0.15		
Н	0.035	0.043	0.90	1.10		
J	0.003	0.007	0.08	0.18		
K	0.014	0.020	0.35	0.51		
L	0.007	0.020	0.20	0.50		

#### **Suggested Solder Pad Layout**





# Electrical Characteristics @ 25°C Unless Otherwise Specified BAS19HE3

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
Reverse Breakdown Voltage	$V_{BR}$	I <sub>R</sub> =100μA	120			V	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =100mA			1	V	
Forward Voltage	V F	I <sub>F</sub> =200mA			1.25	V	
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =V <sub>Rmax</sub>			100	nA	
Neverse Current		'R	i 'R	V <sub>R</sub> =V <sub>Rmax</sub> , T <sub>J</sub> =150°C			100
Junction Capacitance	CJ	V <sub>R</sub> = 0V, f = 1MHz			5	pF	
Reverse Recovery Time	t <sub>rr</sub>	$I_F=I_R=30\text{mA},$ $I_{rr}=0.1\times I_R, R_L=100\Omega$			50	ns	

# BAS20HE3

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>R</sub> =100μA	200			V	
Farmerd Vellers		I <sub>F</sub> =100mA			1	V	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =200mA			1.25	V	
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =V <sub>Rmax</sub>			100	nA	
Reverse Current		'R	·ĸ	V <sub>R</sub> =V <sub>Rmax</sub> , T <sub>J</sub> =150°C			100
Junction Capacitance	CJ	V <sub>R</sub> = 0V, f = 1MHz			5	pF	
Reverse Recovery Time	t <sub>rr</sub>	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$			50	ns	

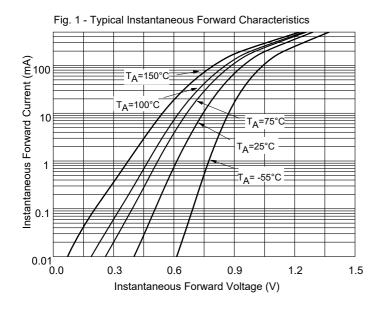
# BAS21HE3

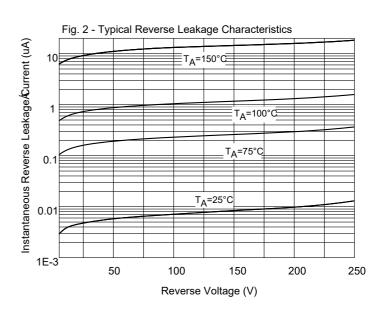
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units			
Reverse Breakdown Voltage	$V_{BR}$	I <sub>R</sub> =100μA	250			V			
Farmer Nelland	V <sub>F</sub>	I <sub>F</sub> =100mA			1	V			
Forward Voltage		I <sub>F</sub> =200mA			1.25	V			
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =V <sub>Rmax</sub>			100	nA			
Reverse Current		'R	'K	·R	٠κ	V <sub>R</sub> =V <sub>Rmax</sub> , T <sub>J</sub> =150°C			100
Junction Capacitance	CJ	V <sub>R</sub> = 0V, f = 1MHz			5	pF			
Reverse Recovery Time	t <sub>rr</sub>	$I_F=I_R=30$ mA, $I_{rr}=0.1\times I_R, R_L=100\Omega$			50	ns			

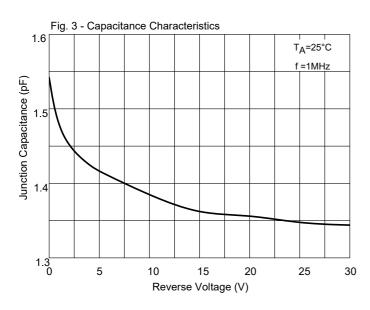
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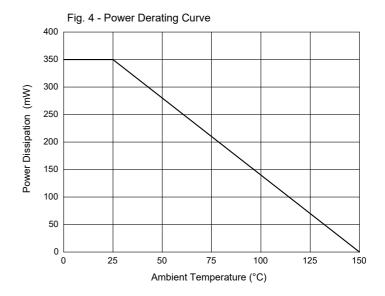


#### **Curve Characteristics**











# **Ordering Information**

Device	Packing		
Part Number-TP	Tape&Reel: 3Kpcs/Reel		

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